

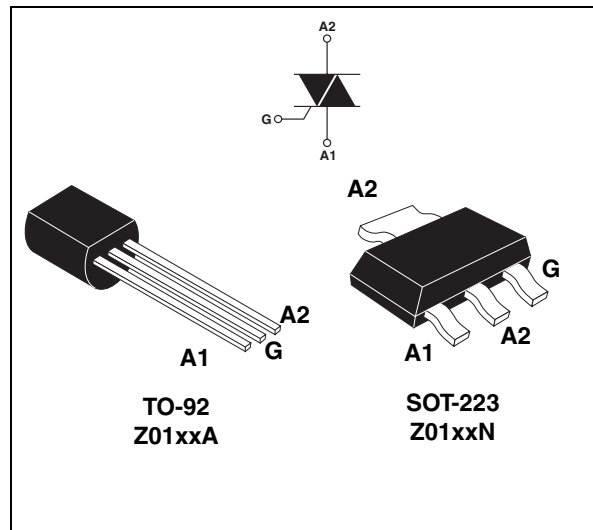
**Standard 1A Triacs****Features**

- On-state rms current,  $I_{T(RMS)}$  1 A
- Repetitive peak off-state voltage,  $V_{DRM}/V_{RRM}$  600 or 800 V
- Triggering gate current,  $I_{GT(Q1)}$  3 to 25 mA

**Description**

The Z01 series is suitable for general purpose AC switching applications. These devices are typically used in applications such as home appliances (electrovalve, pump, door lock, small lamp control), fan speed controllers,...

Different gate current sensitivities are available, allowing optimized performance when driven directly through microcontrollers.



# 1 Characteristics

**Table 1. Absolute maximum ratings**

Symbol	Parameter		Value	Unit	
$I_{T(RMS)}$	On-state rms current (full sine wave)	SOT-223	$T_{tab} = 90\text{ °C}$	1	A
		TO-92	$T_L = 50\text{ °C}$		
$I_{TSM}$	Non repetitive surge peak on-state current (full cycle, $T_j$ initial = 25 °C)	F = 50 Hz	t = 20 ms	8	A
		F = 60 Hz	t = 16.7 ms	8.5	
$I^2t$	$I^2t$ Value for fusing	$t_p = 10\text{ ms}$		0.35	A <sup>2</sup> s
dl/dt	Critical rate of rise of on-state current $I_G = 2 \times I_{GT}$ , $t_r \leq 100\text{ ns}$	F = 120 Hz	$T_j = 125\text{ °C}$	20	A/ $\mu$ s
$I_{GM}$	Peak gate current	$t_p = 20\text{ }\mu$ s	$T_j = 125\text{ °C}$	1	A
$P_{G(AV)}$	Average gate power dissipation		$T_j = 125\text{ °C}$	1	W
$T_{stg}$ $T_j$	Storage junction temperature range Operating junction temperature range			- 40 to + 150 - 40 to + 125	°C

**Table 2. Electrical characteristics ( $T_j = 25\text{ °C}$ , unless otherwise specified)**

Symbol	Test conditions	Quadrant		Z01				Unit
				03	07	09	10	
$I_{GT}^{(1)}$	$V_D = 12\text{ V}$ , $R_L = 30\text{ }\Omega$	I - II - III	MAX.	3	5	10	25	mA
		IV		5	7	10	25	
$V_{GT}$		ALL	MAX.	1.3				V
$V_{GD}$	$V_D = V_{DRM}$ , $R_L = 3.3\text{ k}\Omega$ , $T_j = 125\text{ °C}$	ALL	MIN.	0.2				V
$I_H^{(2)}$	$I_T = 50\text{ mA}$		MAX.	7	10	10	25	mA
$I_L$	$I_G = 1.2 I_{GT}$	I - III - IV	MAX.	7	10	15	25	mA
		II		15	20	25	50	
dV/dt <sup>(2)</sup>	$V_D = 67\% V_{DRM}$ gate open $T_j = 110\text{ °C}$		MIN.	10	20	50	100	V/ $\mu$ s
$(dV/dt)_c^{(2)}$	$(dl/dt)_c = 0.44\text{ A/ms}$ , $T_j = 110\text{ °C}$		MIN.	0.5	1	2	5	V/ $\mu$ s

1. Minimum  $I_{GT}$  is guaranteed at 5% of  $I_{GT}$  max.
2. For both polarities of A2 referenced to A1.

**Table 3. Static characteristics**

Symbol	Test conditions		Value	Unit	
$V_{TM}^{(1)}$	$I_{TM} = 1.4 \text{ A}$ , $t_p = 380 \mu\text{s}$	$T_j = 25 \text{ }^\circ\text{C}$	MAX.	1.6	V
$V_{to}^{(1)}$	Threshold voltage	$T_j = 125 \text{ }^\circ\text{C}$	MAX.	0.95	V
$R_d^{(1)}$	Dynamic resistance	$T_j = 125 \text{ }^\circ\text{C}$	MAX.	400	mΩ
$I_{DRM}$ $I_{RRM}$	$V_{DRM} = V_{RRM}$	$T_j = 25 \text{ }^\circ\text{C}$	MAX.	5	μA
		$T_j = 125 \text{ }^\circ\text{C}$		0.5	mA

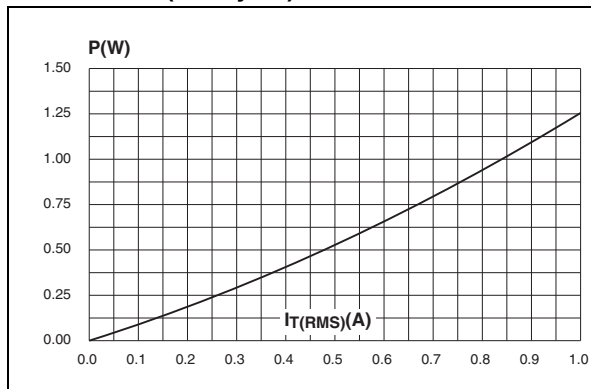
1. For both polarities of A2 referenced to A1.

**Table 4. Thermal resistances**

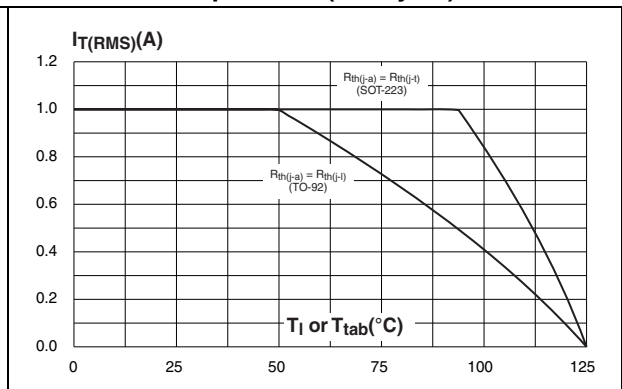
Symbol	Parameter		Value	Unit
$R_{th(j-t)}$	Junction to tab (AC)	SOT-223	25	°C/W
$R_{th(j-l)}$	Junction to lead (AC)	TO-92	60	°C/W
$R_{th(j-a)}$	Junction to ambient	$S^{(1)} = 5 \text{ cm}^2$ SOT-223	60	°C/W
		TO-92	150	

1. S = copper surface under tab.

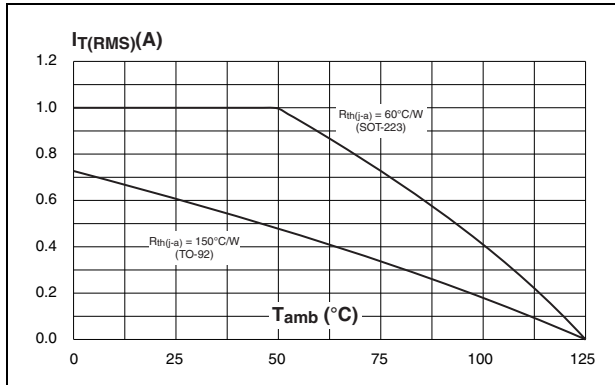
**Figure 1. Maximum power dissipation versus on-state rms current (full cycle)**



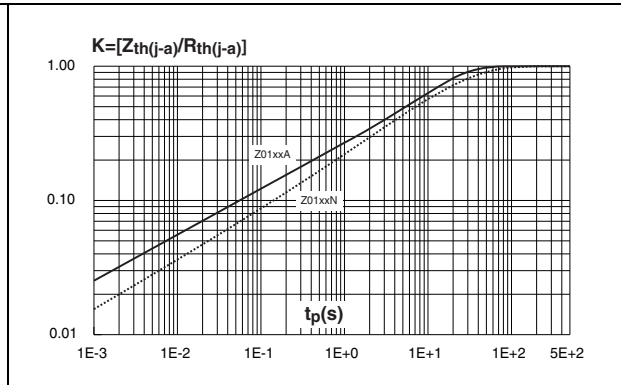
**Figure 2. On-state rms current versus lead (TO-92) or tab (SOT-223) temperature (full cycle)**



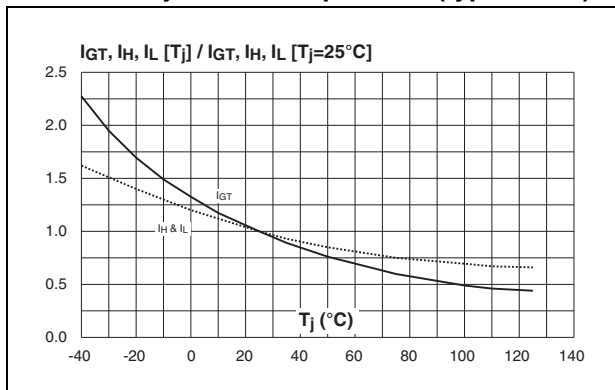
**Figure 3. On-state rms current versus ambient temperature (full cycle)**



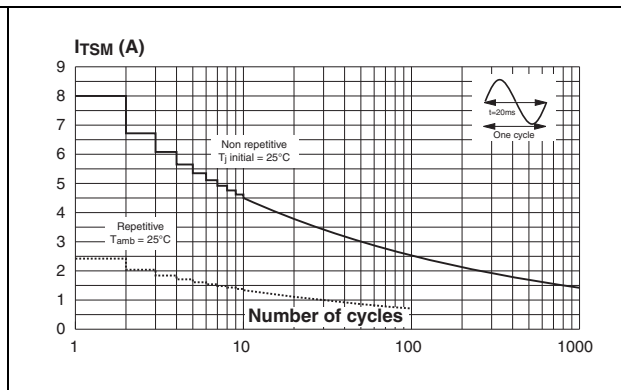
**Figure 4. Relative variation of thermal impedance versus pulse duration**



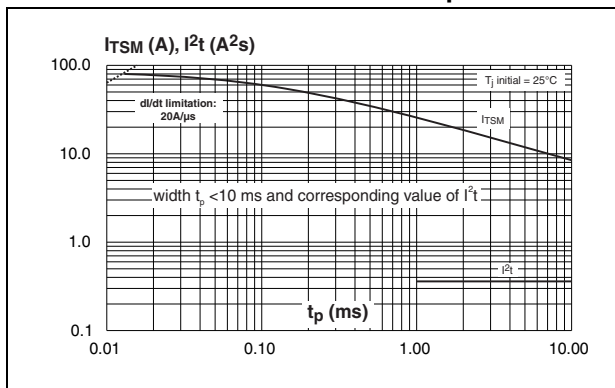
**Figure 5. Relative variation of holding current and latching current versus junction temperature (typ. values)**



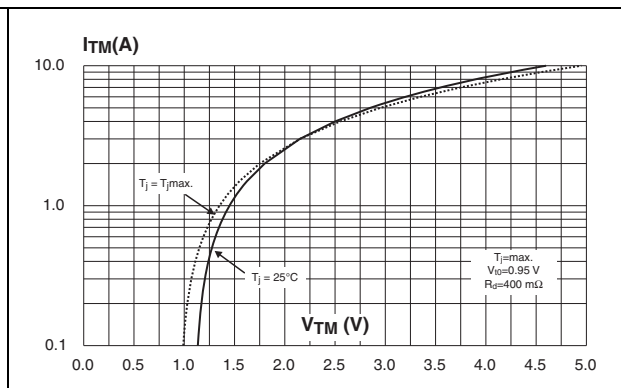
**Figure 6. Surge peak on-state current versus number of cycles**



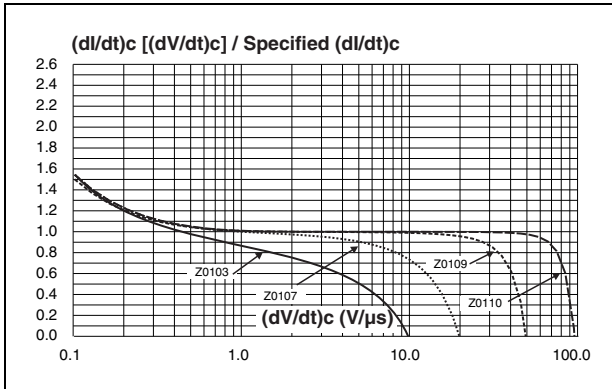
**Figure 7. Non-repetitive surge peak on-state current and corresponding value of  $I^2t$  sinusoidal pulse width**



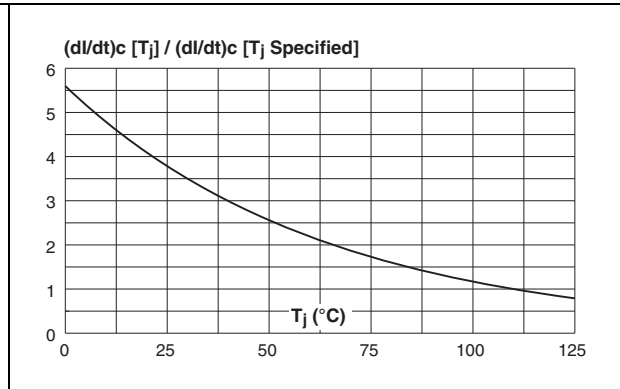
**Figure 8. On-state characteristics (maximum values)**



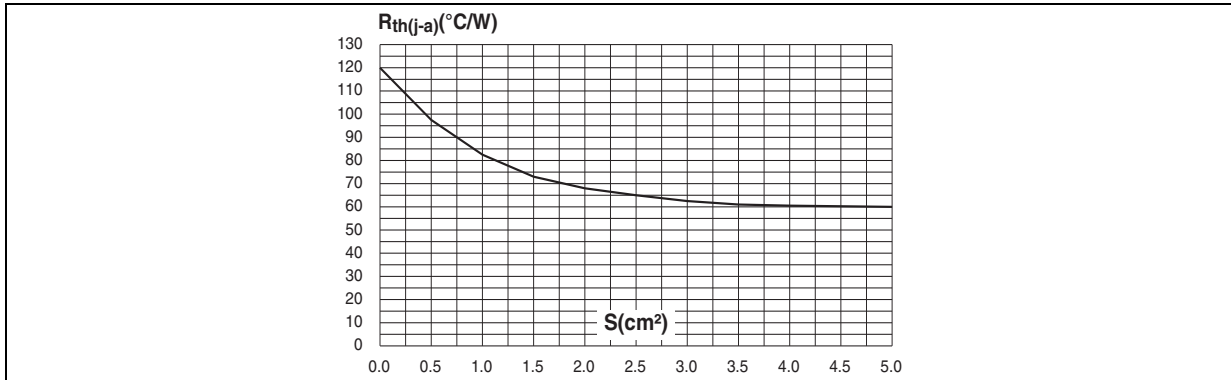
**Figure 9. Relative variation of critical rate of decrease of main current versus (dV/dt)<sub>c</sub> (typical values)**



**Figure 10. Relative variation of critical rate of decrease of main current versus junction temperature**



**Figure 11. SOT-223 thermal resistance junction to ambient versus copper surface under case (printed circuit board FR4, copper thickness; 35 μm)**



## 2 Ordering information

Figure 12. Ordering information scheme

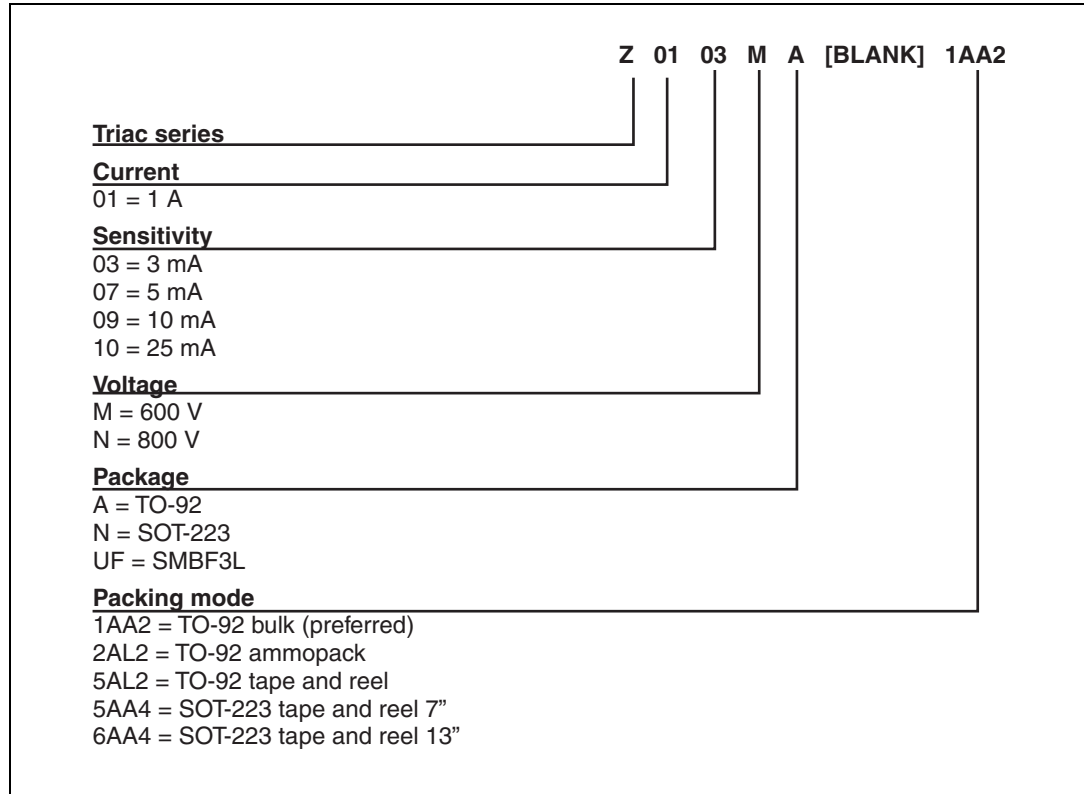


Table 5. Product Selector

Part Number	Voltage			Sensitivity	Type	Package
	600 V	700 V	800 V			
Z0103MA	X			3 mA	Standard	TO-92
Z0103MN	X			3 mA	Standard	SOT-223
Z0103SA		X		3 mA	Standard	TO-92
Z0103SN		X		3 mA	Standard	SOT-223
Z0103NA			X	3 mA	Standard	TO-92
Z0103NN			X	3 mA	Standard	SOT-223
Z0107MA	X			5 mA	Standard	TO-92
Z0107MN	X			5 mA	Standard	SOT-223
Z0107SA		X		5 mA	Standard	TO-92
Z0107SN		X		5 mA	Standard	SOT-223
Z0107NA			X	5 mA	Standard	TO-92
Z0107NN			X	5 mA	Standard	SOT-223
Z0109MA	X			10 mA	Standard	TO-92
Z0109MN	X			10 mA	Standard	SOT-223
Z0109SA		X		10 mA	Standard	TO-92
Z0109SN		X		10 mA	Standard	SOT-223
Z0109NA			X	10 mA	Standard	TO-92
Z0109NN			X	10 mA	Standard	SOT-223
Z0110MA	X			25 mA	Standard	TO-92
Z0110MN	X			25 mA	Standard	SOT-223
Z0110SA		X		25 mA	Standard	TO-92
Z0110SN		X		25 mA	Standard	SOT-223
Z0110NA			X	25 mA	Standard	TO-92
Z0110NN			X	25 mA	Standard	SOT-223

### 3 Packaging information

- Epoxy meets UL94, V0
- Lead-free packages

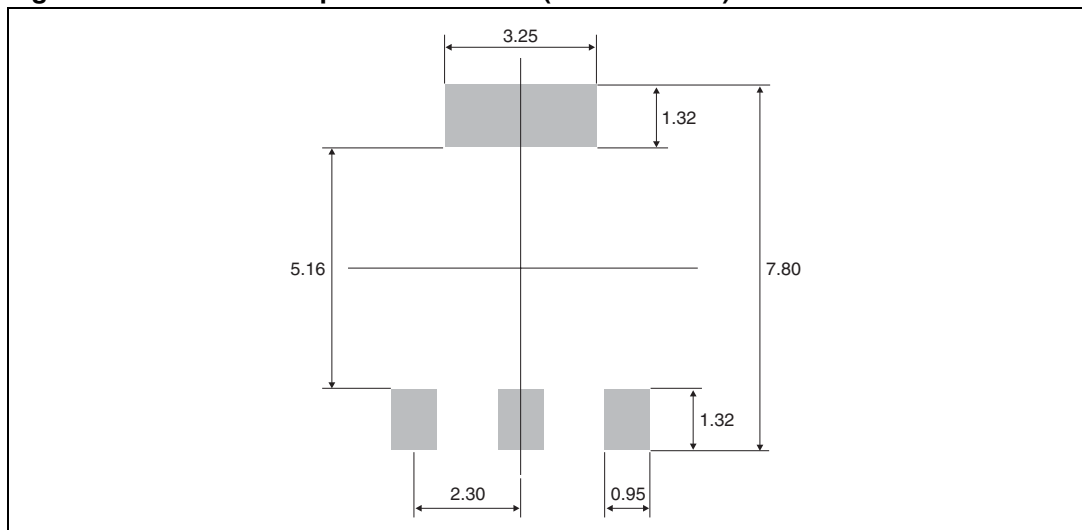
In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK® is an ST trademark.

**Table 6. SOT-223 dimensions**

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.80			0.071
A1		0.02	0.10		0.001	0.004
B	0.60	0.70	0.85	0.024	0.027	0.033
B1	2.90	3.00	3.15	0.114	0.118	0.124
c	0.24	0.26	0.35	0.009	0.010	0.014
D <sup>(1)</sup>	6.30	6.50	6.70	0.248	0.256	0.264
e		2.3			0.090	
e1		4.6			0.181	
E <sup>(1)</sup>	3.30	3.50	3.70	0.130	0.138	0.146
H	6.70	7.00	7.30	0.264	0.276	0.287
V	10° max					

1. Do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.15mm (0.006inches)

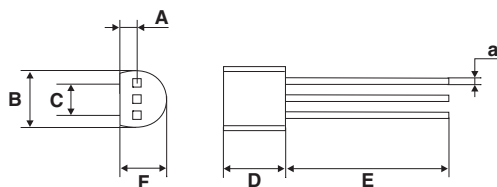
**Figure 13. SOT-223 footprint dimensions (in millimeters)**





**Table 7. TO-92 dimensions**

REF.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A		1.35			0.053	
B			4.70			0.185
C		2.54			0.100	
D	4.40			0.173		
E	12.70			0.500		
F			3.70			0.146
a			0.50			0.019



## 4 Ordering information

**Table 8. Ordering information**

Order code <sup>(1)</sup>	Marking <sup>(1)</sup>	Package	Weight	Base quantity	Delivery mode
Z01xxyA 1AA2	Z01xxyA	TO-92	0.2 g	2500	Bulk
Z01xxyA 2AL2	Z01xxyA			2000	Ammopack
Z01xxyA 5AL2	Z01xxyA				Tape and reel
Z0103yN 5AA4	Z3y	SOT-223	0.12 g	1000	Tape and reel 7"
Z0107yN 5AA4	Z7y				
Z0109yN 5AA4	Z9y				
Z0103yN 6AA4	Z3y			4000	Tape and reel 13"
Z0107yN 6AA4	Z7y				
Z0109yN 6AA4	Z9y				

1. xx = sensitivity, y = voltage

## 5 Revision history

**Table 9. Document revision history**

Date	Revision	Changes
Oct-2001	4	Last update.
10-Feb-2005	5	Package: TO-92 tape and reel delivery mode 5AL2 added.
09-May-2005	6	Table 4 on page 2: typo. mistake corrected 1. (dV/dt) <sub>c</sub> instead of (dI/dt) <sub>c</sub> 2. V/μs unit instead of A/ms
21-Apr-2006	7	Reformatted to current standard. Table 2 on page 2: Typo corrected. Values for I <sub>GT</sub> split into two separate rows.
10-Oct-2006	8	Table 2: modified test conditions for (dV/dt) <sub>c</sub> . Changed "ambient" to "lead or tab" in Figure 2.
20-Oct-2010	9	Package: SOT-223 13" tape and reel added = 6AA4

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